



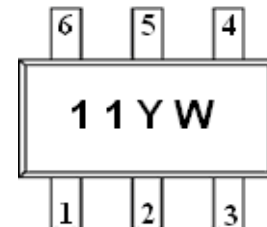
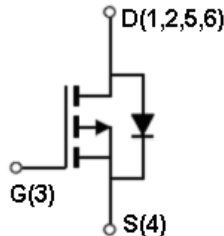
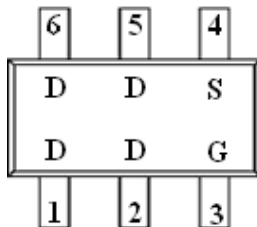
General Description

AFP7611, P-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge. These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

Features

- -20V/-3.0A, $R_{DS(ON)}=110m\Omega@V_{GS}=-4.5V$
- -20V/-2.4A, $R_{DS(ON)}=135m\Omega@V_{GS}=-2.5V$
- -20V/-2.0A, $R_{DS(ON)}=180m\Omega@V_{GS}=-1.8V$
- Super high density cell design for extremely low $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- SOT-363 package design

Pin Description (SOT-363)



Application

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- Net Working System

Pin Define

Pin	Symbol	Description
1	D	Drain
2	D	Drain
3	G	Gate
4	S	Source
5	D	Drain
6	D	Drain

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFP7611S36RG	11YW	SOT-363	Tape & Reel	3000 EA

- ※ 11 parts code
- ※ Y year code (0 ~ 9)
- ※ W week code (A ~ Z = 1 ~ 26 / a ~ z = 27 ~ 52)
- ※ AFP7611S36RG : 7" Tape & Reel ; Pb- Free ; Halogen -Free



Absolute Maximum Ratings

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	-20	V
Gate –Source Voltage	V _{GSS}	±12	V
Continuous Drain Current(T _J =150°C)	I _D	T _A =25°C -3.0	A
		T _A =70°C -2.0	
Pulsed Drain Current	I _{DM}	-8	A
Continuous Source Current(Diode Conduction)	I _S	-1.4	A
Power Dissipation	P _D	T _A =25°C 1.5	W
		T _A =70°C 0.8	
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	120	°C/W

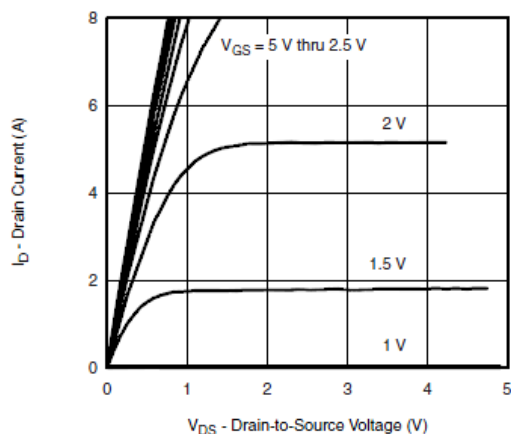
Electrical Characteristics

(T_A=25°C Unless otherwise noted)

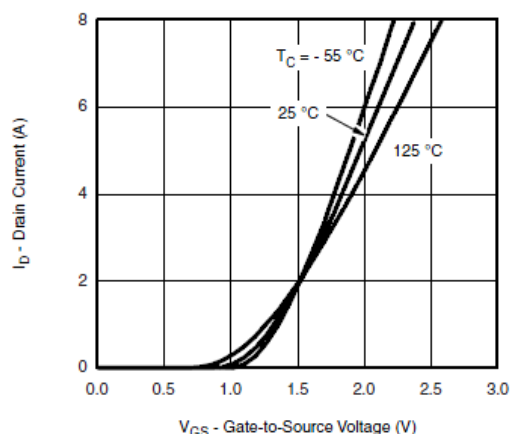
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =-250uA	-20			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250uA	-0.5	-0.7	-1.0	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±12V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-16V, V _{GS} =0V			-1	uA
		V _{DS} =-16V, V _{GS} =0V T _J =85°C			-30	
On-State Drain Current	I _{D(on)}	V _{DS} ≤ -5V, V _{GS} =-4.5V	-4			A
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-3.0A		95	110	mΩ
		V _{GS} =-2.5V, I _D =-2.4A		115	135	
		V _{GS} =-1.8V, I _D =-2.0A		155	180	
Forward Transconductance	g _{FS}	V _{DS} =-5V, I _D =-2.8A		6.5		S
Diode Forward Voltage	V _{SD}	I _S =-1.25A, V _{GS} =0V		-0.75	-1.3	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =-10V, V _{GS} =-4.5V I _D =-2.9A		5.8	10	nC
Gate-Source Charge	Q _{gs}			1.1		
Gate-Drain Charge	Q _{gd}			1.1		
Input Capacitance	C _{iss}	V _{DS} =-10V, V _{GS} =0V f=1MHz		550	750	pF
Output Capacitance	C _{oss}			90		
Reverse Transfer Capacitance	C _{rss}			70		
Turn-On Time	t _{d(on)}	V _{DD} =-10V, R _L =10Ω I _D =-1.0A, V _{GEN} =-4.5V R _G =6Ω		1.0	2.0	us
	t _r			2.0	3.0	
Turn-Off Time	t _{d(off)}			4.0	6.0	
	t _f			4.0	6.0	



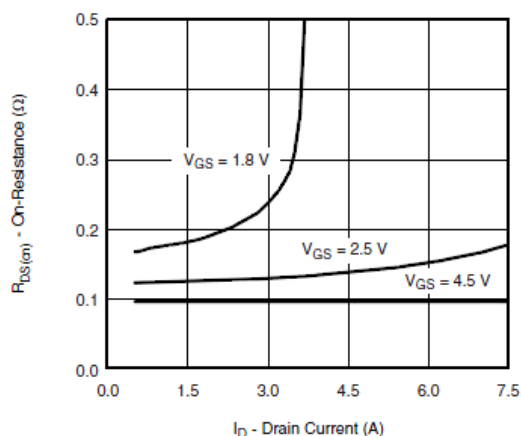
Typical Characteristics



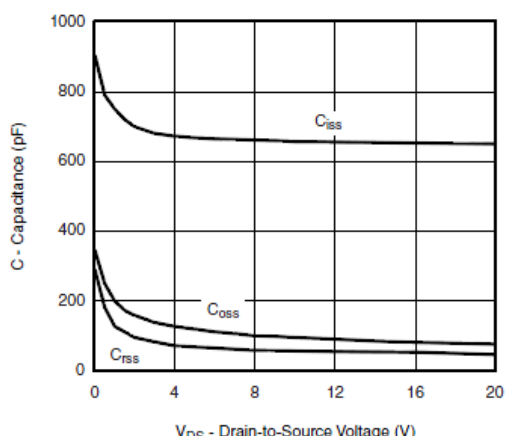
Output Characteristics



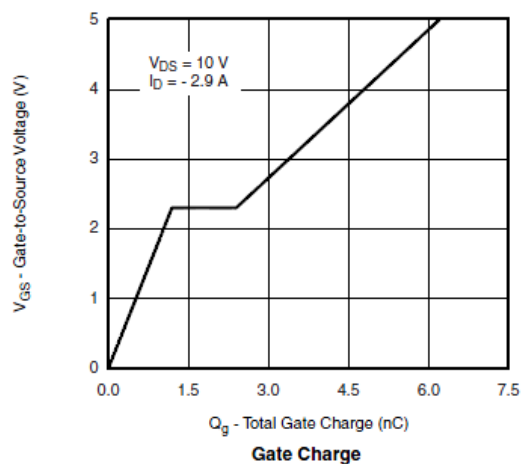
Transfer Characteristics



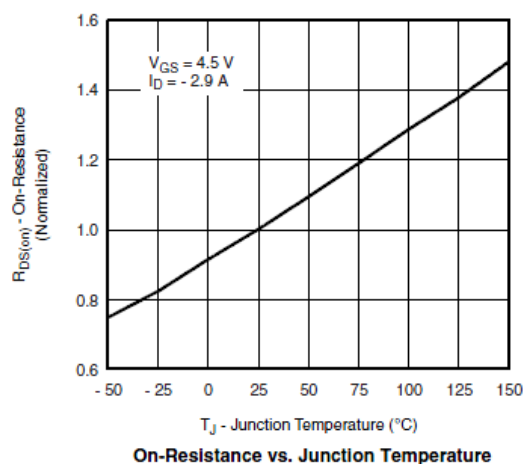
On-Resistance vs. Drain Current



Capacitance



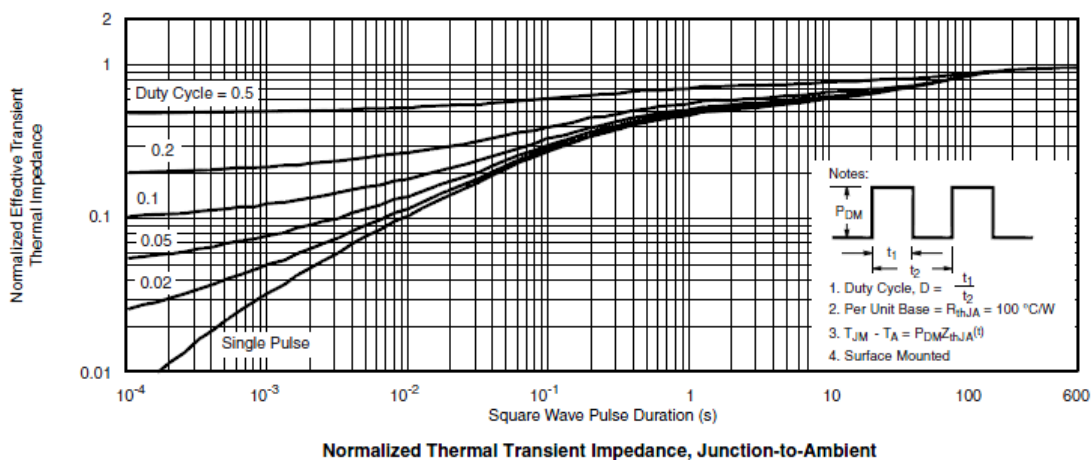
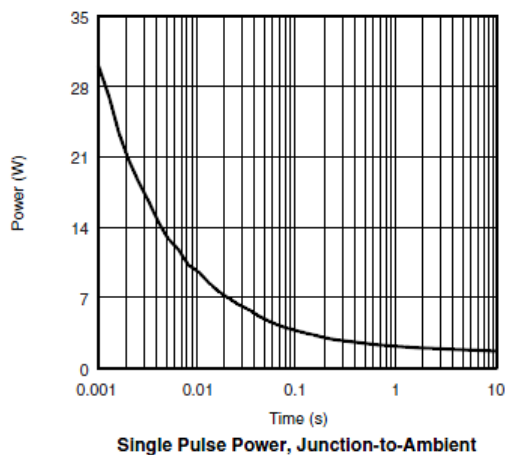
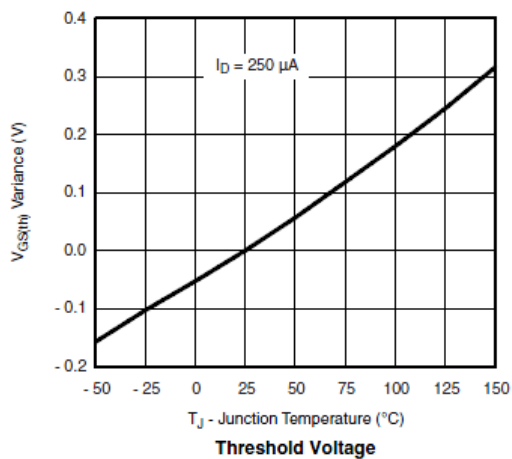
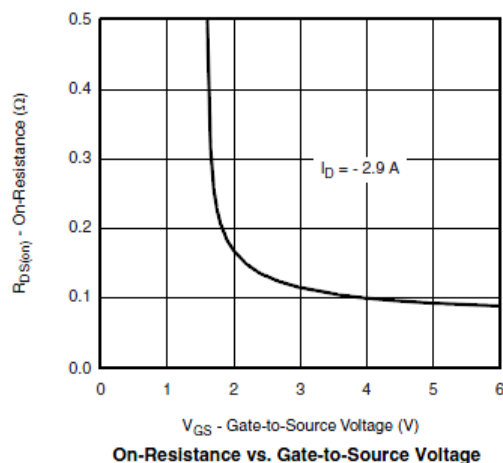
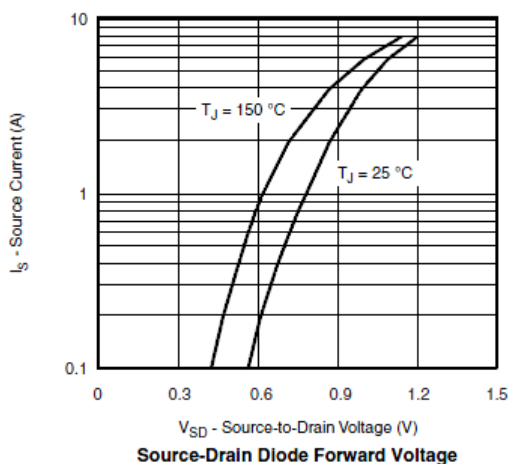
Gate Charge



On-Resistance vs. Junction Temperature



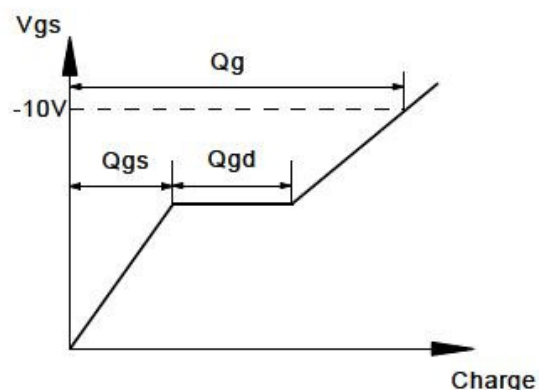
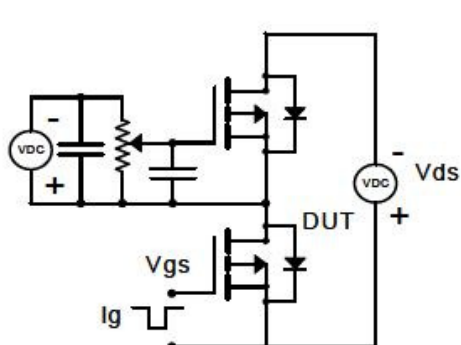
Typical Characteristics



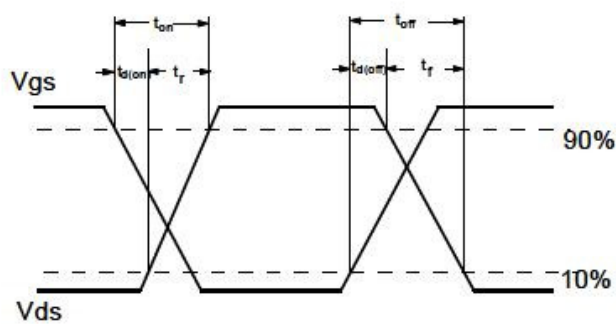
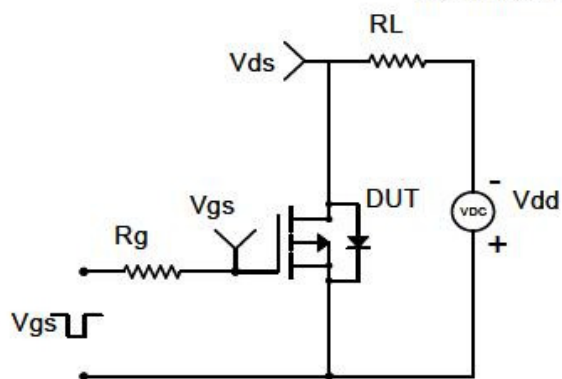


Typical Characteristics

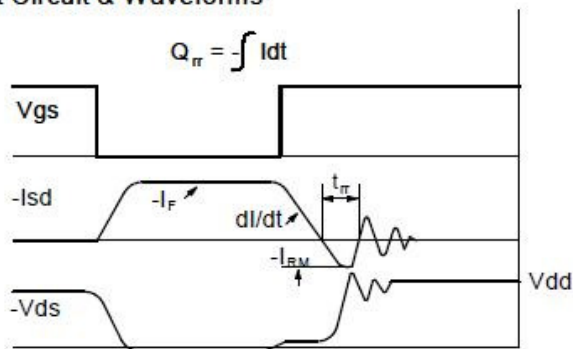
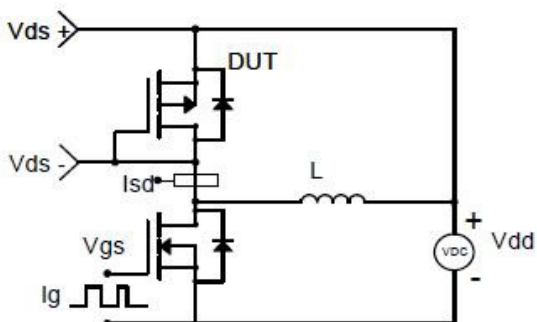
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

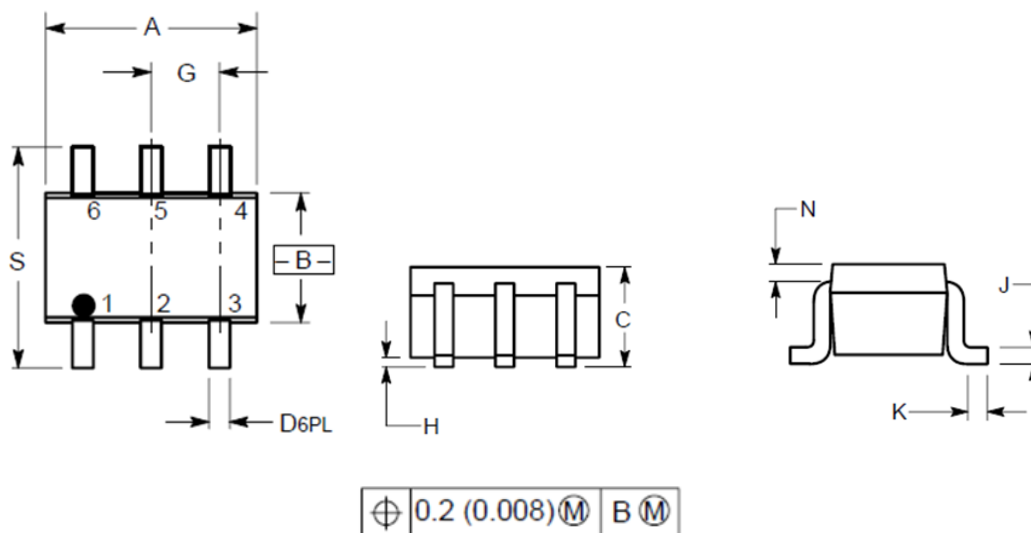


Diode Recovery Test Circuit & Waveforms





Package Information (SOT-363)



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.071	0.087	1.80	2.20
B	0.045	0.053	1.15	1.35
C	0.031	0.043	0.80	1.10
D	0.004	0.012	0.10	0.30
G	0.026 BSC		0.65 BSC	
H	---	0.004	---	0.10
J	0.004	0.010	0.10	0.25
K	0.004	0.012	0.10	0.30
N	0.008 REF		0.20 REF	
S	0.079	0.087	2.00	2.20

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